

## **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C				
00)/	$80m\Omega @ V_{GS} = 4.5V$	-2.7A				
-20V	110m $\Omega$ @ V <sub>GS</sub> = 2.5V	-2.1A				

## **Description**

This MOSFET has been designed to minimize the on-state resistance  $(R_{DS(on)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

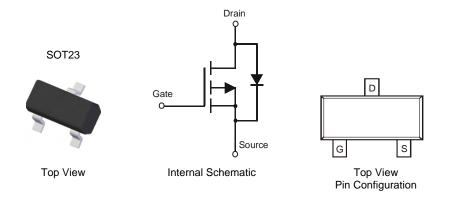
- Backlighting
- Power Management Functions
- DC-DC Converters
- Motor control

#### **Features**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe.
  Solderable per MIL-STD-202, Method 208 63
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (approximate)



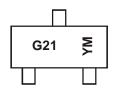
# **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMG2301U-7	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

# **Marking Information**



G21 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009) M = Month (ex: 9 = September)

Date Code Key

Year	2009	2010	20	11	2012	2013	2014	2015	20	16	2017	2018
Code	W	X	\	1	Z	Α	В	С		D	Е	F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

# **DMG2301U**

### P-CHANNEL ENHANCEMENT MODE MOSFET



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		$V_{DSS}$	-20	V	
Gate-Source Voltage		$V_{GSS}$	±8	V	
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	-2.7 -2.1	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = -2.5V	I <sub>D</sub>	-2.1 -1.7	А		
Pulsed Drain Current (Note 6)		I <sub>DM</sub>	-27	Α	

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_{D}$	0.8	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	R <sub>0JA</sub>	157	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

	_					
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	-1.0	μΑ	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_		±100	nA	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.45	_	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	J			80	mΩ	$V_{GS} = -4.5V$ , $I_D = -2.8A$
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)		_	110	11177	$V_{GS} = -2.5V$ , $I_D = -2.0A$
Forward Transfer Admittance	Y <sub>fs</sub>	_	10	_	S	$V_{DS} = -5V, I_{D} = -2.8A$
Diode Forward Voltage	$V_{SD}$	_	-0.75	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 8)			_	_		
Input Capacitance	C <sub>iss</sub>	_	608	_	pF	\\ C\\ \\ C\\ \\
Output Capacitance	Coss	_	82	_	pF	$V_{DS} = -6V, V_{GS} = 0V$ - f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	72	_	pF	1 - 1.000112
Gate Resistance	$R_{G}$	_	44.9	_	Ω	$V_{GS} = 0V, V_{DS} = 0V, f = 1.0MHz$
Total Gate Charge	$Q_g$	_	6.5	_	nC	
Gate-Source Charge	$Q_{gs}$	_	0.9	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V, I_{D} = -3A$
Gate-Drain Charge	$Q_{gd}$	_	1.5	_	nC	
Turn-On Delay Time	t <sub>D(on)</sub>	_	12.5	40	ns	
Turn-On Rise Time	t <sub>r</sub>	_	10.3	30	ns	$V_{DS} = -10V$ , $V_{GS} = -4.5V$ ,
Turn-Off Delay Time	t <sub>D(off)</sub>	_	46.5	140	ns	$R_L = 10\Omega$ , $R_G = 1.0\Omega$ , $I_D = -1A$
Turn-Off Fall Time	t <sub>f</sub>		22.2	66	ns	

Notes:

- 3. Device mounted on FR-4 PCB with minimum recommended pad layout.
- 4. Repetitive rating, pulse width limited by junction temperature.5. Short duration pulse test used to minimize self-heating effect.
- 6. Guaranteed by design. Not subject to production testing.